

1. Introduction, The CMOS Transistor

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VLSI Design
Fall 2020

August 27, 2020

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Goals of This Course

Learn the principles of VLSI design

- Learn to design and implement state-of-the-art digital Very Large Scale Integrated (VLSI) chips using CMOS technology
- Understand the complete design flow
- Be able to design state-of-the-art CMOS chips in industry

Employ hierarchical design methods

- Use integrated circuit cells as building blocks
- Understand design issues at the layout, transistor, logic and register-transfer levels
- Use **Commercial Design Software** in the lab

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Course Information

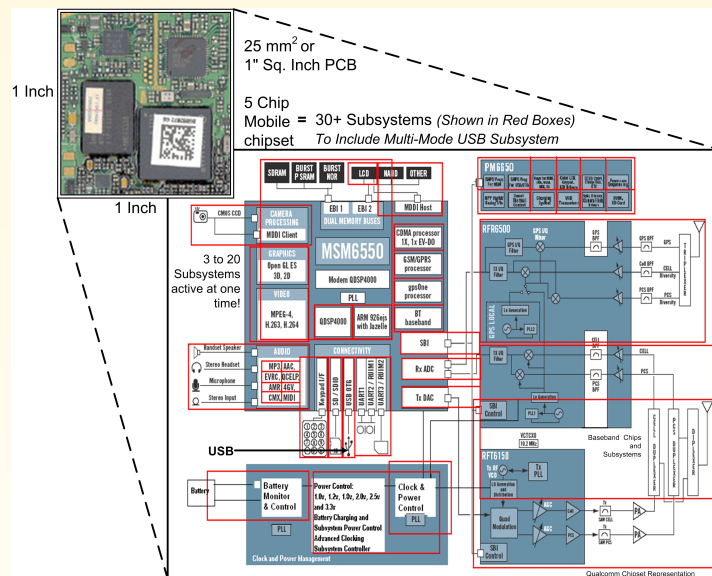
Instructor

- Jacob A. Abraham
- jaa@cerc.utexas.edu, +1-512-471-8983
- <http://www.cerc.utexas.edu/~jaa/>

More on the course

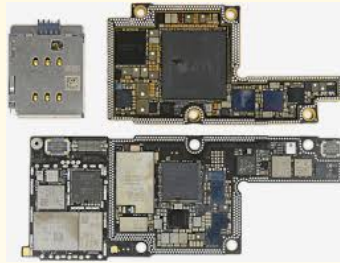
- Course Web Page (information duplicated on Canvas):
 - EE 382M: <http://www.cerc.utexas.edu/~jaa/vlsi/>
- Prerequisites: logic design, basic computer organization
- Textbook: Weste and Harris, CMOS VLSI Design: A Circuits and Systems Perspective, Addison Wesley/Pearson, 4th Edition, 2011
- Lectures and discussion in class will cover basic principles
- Homework, Laboratory exercises will help you gain a practical understanding of the subject

Example System-on-a-Chip (SoC)



From Chips on PCB to SoCs (ChipEstimate.com)

System Trends



iPhone X board

iPhone X Teardown (techspot.com)



Yesterday's science fiction (the "Tricorder" from *Star Trek*), tomorrow's medical diagnostic device

Where is this leading to?

New Opportunities

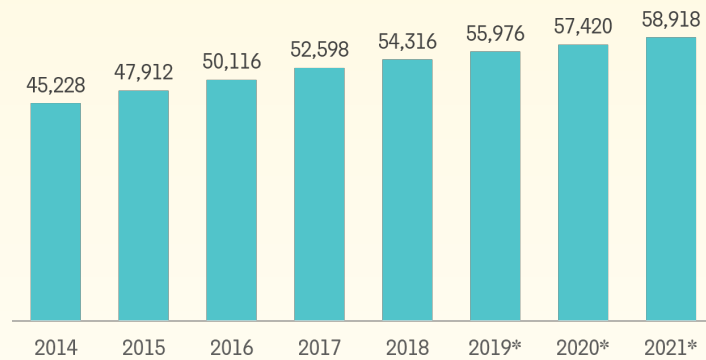


Source: Silicon Catalyst

Projected Growth in Self-Driving Market

Advanced Driver-Assistance Systems

ADAS Production, in thousand Units, Global, 2014 – 2021*



*Forecast

Source: Deutsche Bank



Estimates of 25 – 100 Billion IoT devices by 2020

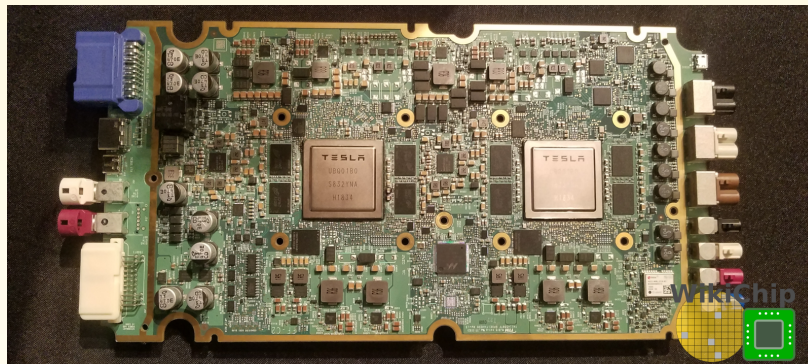
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Tesla's Neural Processor in the FSD Chip



fuse.wikichip.org

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A Brief History of the Trnasistor

Some of the events which led to the microprocessor

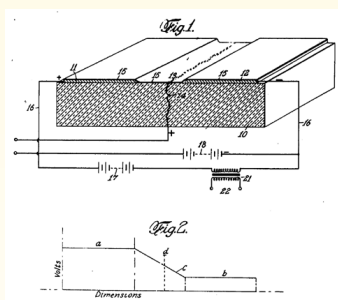
Photographs in the following are from "State of the Art: A photographic history of the integrated circuit," Stan Augarten, Ticknor & Fields, 1983.

They can also be viewed on the Smithsonian web site,
<http://smithsonianchips.si.edu/>

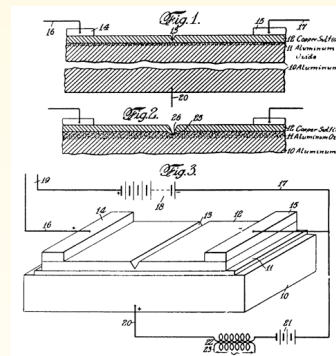
Early Ideas Leading to the Transistor

J. W. Lilienfelds patents

1930: "Method and apparatus
for controlling electric
currents," U.S. Patent
1,745,175



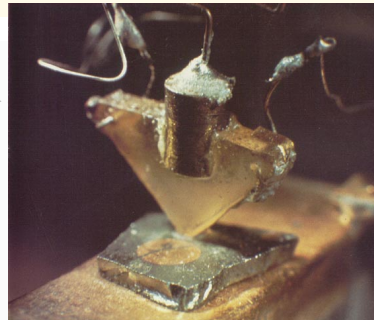
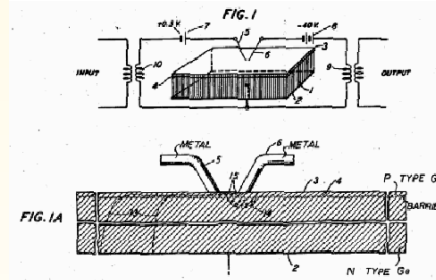
1933: "Device for controlling
electric current," U. S. Patent
1,900,018



Key Developments at Bell Labs

- 1940: Ohl develops the PN Junction
- 1945: Shockley's laboratory established
- 1947: Bardeen and Brattain create point contact transistor (U.S. Patent 2,524,035)

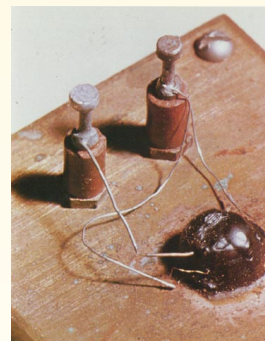
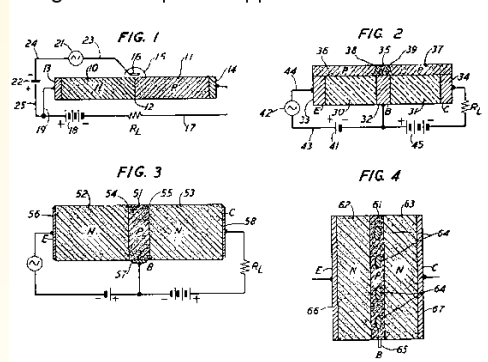
Diagram from patent application



Developments at Bell Labs, Contd

- 1951: Shockley develops a junction transistor manufacturable in quantity (U.S. Patent 2,623,105)

Diagram from patent application



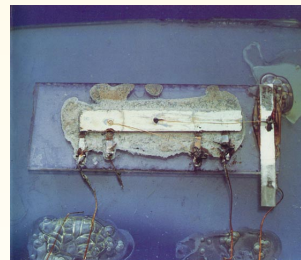
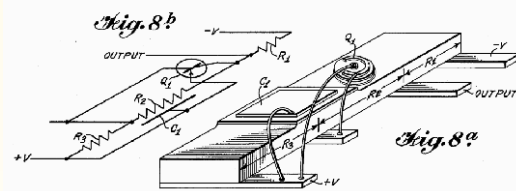
1950s Silicon Valley

- 1950s: Shockley in Silicon Valley
- 1955: Noyce joins Shockley Laboratories
- 1954: The first transistor radio
- 1957: Noyce leaves Shockley Labs to form Fairchild with Jean Hoerni and Gordon Moore
- 1958: Hoerni invents technique for diffusing impurities into Si to build planar transistors using a SiO_2 insulator
- 1959: Noyce develops first true IC using planar transistors, back-to-back PN junctions for isolation, diode-isolated Si resistors and SiO_2 insulation with evaporated metal wiring on top

The Integrated Circuit (IC)

- 1958: Jack Kilby, working at TI, dreams up the idea of a monolithic "integrated circuit" (IC)
 - Components connected by hand-soldered wires and isolated by shaping, PN-diodes used as resistors (U.S. Patent 3,138,743)
- 1959: Robert Noyce, at Fairchild, independently develops the IC, solving many practical problems
- 2000: Kilby receives Nobel Prize in Physics (Noyce was no longer alive)

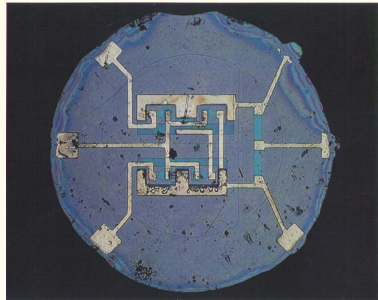
Diagram from Kilby patent application



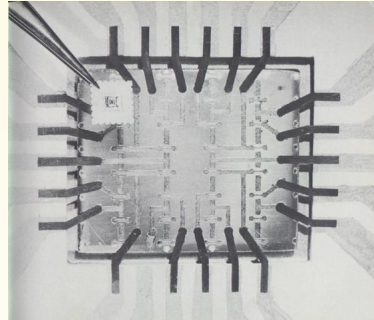
ICs, Cont'd

- 1961: TI and Fairchild introduce the first logic ICs (\$50 in quantity)
- 1962: RCA develops the first MOS transistor

Fairchild Bipolar RTL Flop-Flop

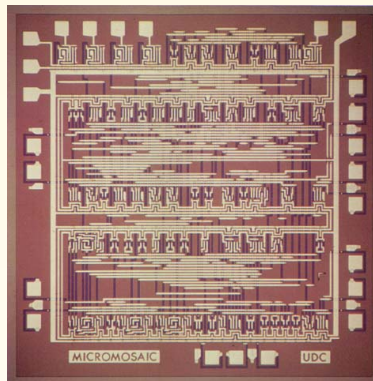


RCA 16-transistor MOSFET IC



Computer-Aided Design (CAD)

- 1967: Fairchild develops the Micromosaic IC using CAD
 - Final Al layer of interconnect could be customized for different application

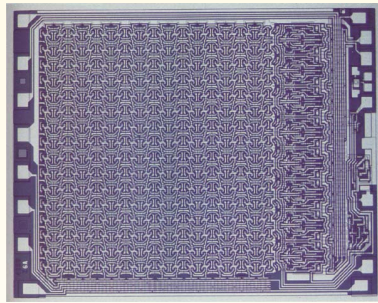


- 1968: Noyce, Moore leave Fairchild, start Intel

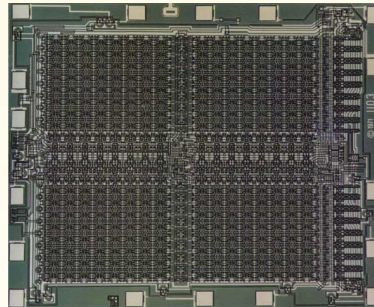
Static and Dynamic Random Access Memories (RAMs)

- 1970: Fairchild introduces the 4100, 256-bit Static Random Access Memory (SRAM)
- 1970: Intel starts selling a 1K-bit Dynamic RAM (DRAM), the 1103

Fairchild 4100 256-bit SRAM

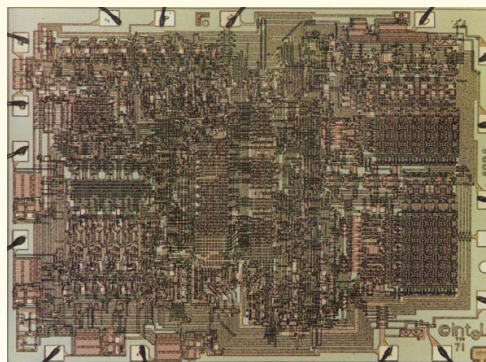


Intel 1103 1K-bit DRAM

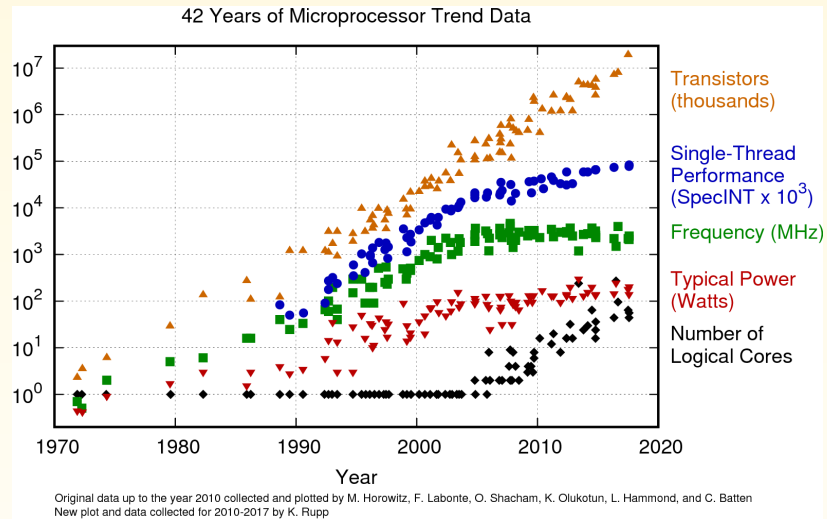


The Microprocessor!

- 1971: Intel introduces the first microprocessor, the 4004 (originally designed as a special circuit for a customer)



MOS Technology Trends – Moore's Law



Original data to 2010 by Horowitz et al. New data for 2010–2017 by K. Rupp

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VLSI Design – The Big Picture

What do you do with a billion transistors?

- **Important to identify potential applications**
- Designing systems for a particular application:
 - Identify sub-functions
 - Design system using a variety of powerful Computer-Aided Design (CAD) tools
- Use a process relevant to industry
 - **Course developed with industry leaders in Austin**

Think of potential new applications

- Improving quality of life
 - Health
 - Education
 - Entertainment

Communication revolution
(poor fisherman checking
prices to decide where to sell)



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Work in the Course

- Lectures
 - Read sections in text and slides before class
- Homework problems
 - Solve related problems posted every week
- Laboratory exercises
 - Three major exercises dealing with various aspects of VLSI design
 - Complete each section before the deadline
- Project (EE 382M)
 - Your opportunity to design a chip of interest to you
 - Design could be completed to the point where it could be fabricated by following process covered this course
- **Course involves a large amount of work throughout the semester**

Types of Integrated Circuit (IC) Designs

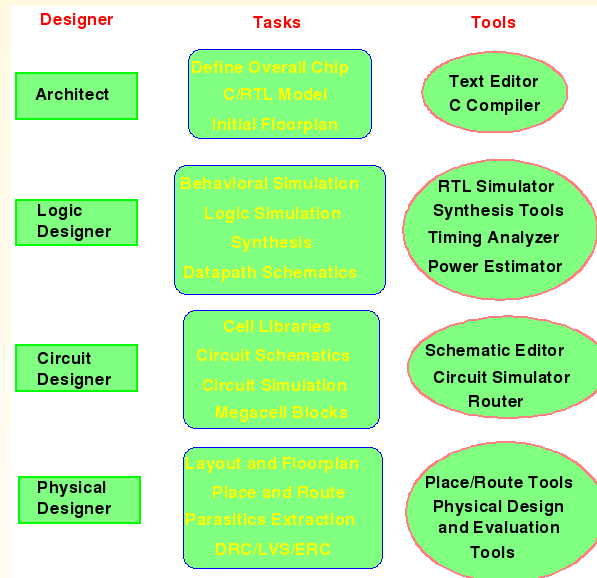
- IC Designs can be Digital (covered in this course), Analog, RF or mixed-signal

Digital designs

- Full Custom
 - Every transistor designed and laid out by hand
 - Used for memories, datapaths in high performance processors, etc.
- ASIC (Application-Specific Integrated Circuits)
 - Designs synthesized automatically from a high-level language description
- Semi-Custom
 - Mixture of custom and synthesized modules

This course will cover all these design techniques

Steps in Designing Hardware



Laboratory Exercises

Exercise 1: Design, layout and evaluation of a register file

- Use Cadence layout software, HSpice simulation

Exercise 2: Design and evaluation of an ALU with standard cell libraries

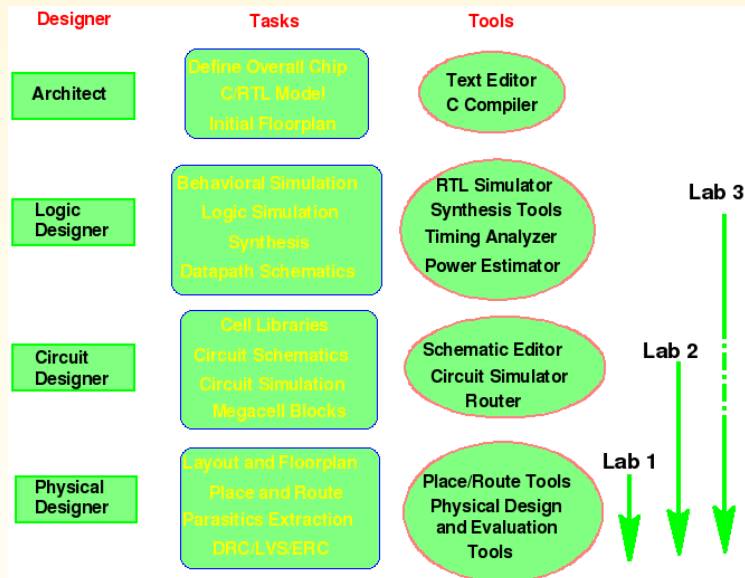
- Cadence schematic editor, Synopsys static timing analysis, Cadence place-and-route

Exercise 3: RT-level design and evaluation of bus controller

- Synopsys simulation, Synopsys synthesis, Cadence place-and-route

- **We will use an academic 45 nm standard cell library for the lab exercises**

Steps in Designing Hardware



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Purpose of Laboratory Exercises

Mix of tools from different vendors mirrors industry practice

- ① Familiarity with layout, circuit simulation, timing
- ② Learn schematic design, timing optimization
- ③ Learn Register-Transfer level design, system simulation, logic synthesis and automatic place-and-route

Commercial CAD Tools

- Cadence, Synopsys
- Commercial software is powerful, but very complex
 - Designers sent to long training classes
 - Students will benefit from using the software, but we don't have the luxury of long training
 - TA has experience with the software
- Start work early in the lab
 - Unavailability of workstations is no excuse for late submissions
 - Plan designs carefully and save work frequently

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Teaching Assistant and Laboratory

TA

- Akib Shah

Laboratory

- TA will hold demonstrations and discussion sessions
- Goal is to quickly learn the use of the tools
- Attend any session you wish
- You may need to go to your assigned section to demonstrate your laboratory exercise

Term Project (Graduate Students)

- Form 2 – 3 person teams
- Pick project
 - Based on something of interest to you
 - Discuss thoughts with me
 - Look at list of suggestions
- Complete design
- Evaluate design (for performance, power, etc.)
- Demonstrate operation
- Write report
- **Meet published deadlines**

Exams, Homework and Project

- Two exams, in class, open book and notes
- Final Exam (Undergraduates)
- Term project (Graduates)
- Penalty for late submission in labs: 5% per working day, maximum 25% (no submissions accepted after 5 working days)
- Bonus (for labs), early submission: 5% per working day (maximum 10%)
- Homework: work in teams
 - Homework due one week after it is posted (upload your work to Canvas)
 - Submit one homework per "team", note all names on the sheet
 - Solutions will be posted on Canvas one week after problem set posted

Grading Policy

Grades will be absolute

- Grades based on demonstration of your knowledge of VLSI design
- Knowledge of fundamentals: homework, exams
- Practical application: laboratory exercises, project

Graduate Students

Homework	10%
Exams I and II	30%
Laboratory	45%
Term Project	15%

Undergraduate Students

Homework	10%
Exams I and II	25%
Laboratory	45%
Final Exam	20%

Academic Honesty

Develop professional ethics

- No cheating! This includes providing information about your work to, or receiving information from, another student
- Do not leave your work around for others to copy
- Protect your computer files
- Feel free to discuss homework, laboratory exercises with classmates, TAs and the instructors
- Homework exercises can be submitted by a team
- You can share knowledge of the tools
- However, do your designs and lab exercises by yourself and the submitted work should be your own

University Honor Code

<https://law.utexas.edu/student-affairs/academic-services/policies-and-procedures/honor-code/>

What Will You Learn?

- How integrated circuits work
- How to design chips with millions of transistors
 - Ways of managing the complexity
 - Use of tools to speed up the design process
- Identifying performance bottlenecks
- Ways of speeding up circuits
- Making sure the designs are correct
- Making the chips testable after manufacture
- Other issues: effect of technologies, reducing power consumption, etc.

Learning General Principles

- Chip design involves optimization, tradeoffs
- Need the ability to work as part of a group
- Technology changes fast, so it is important to understand the general principles which would span technology generations
- Systems are implemented using building blocks (which may be technology-specific)
 - Example: relays \rightarrow tubes \rightarrow bipolar transistors \rightarrow MOS transistors (which are like relay switches) \rightarrow Carbon nanotube transistor \rightarrow ??
- **Lot of work in course, but you'll learn a lot**

Voltages and Logic Levels

Represent logic levels with different voltages

- Ground (GND, V_{SS}) = 0V – can represent logic 0
- Power supply (V_{DD}) can represent logic 1

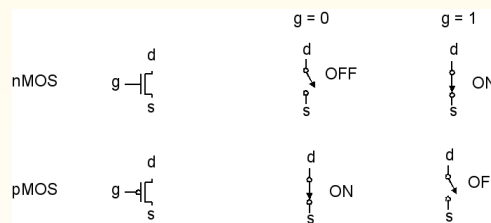
Decreasing voltages

- In 1980s, $V_{DD} = 5V$
- V_{DD} has been decreasing in modern processes
 - High V_{DD} would damage modern tiny transistors
 - Lower V_{DD} saves power
- $V_{DD} = 3.3, 2.5, 1.8, 1.5, 1.2, 1.0, 0.9, \dots$

Metal Oxide Semiconductor (MOS) Transistors as Switches

Can view MOS transistors as electrically controlled switches

- Transistors we will use are built on a semiconductor with the control isolated from the semiconductor by an oxide
 - We'll see more of the MOS technology in the next class
- Two types of transistors, **nMOS** and **pMOS**
- The three terminals are gate (the control), source and drain
- Voltage (logic 0 or 1) on the gate controls source-drain path
- The nMOS (pMOS) switch passes a 0 (1) well**
 - The voltages are degraded for the other values

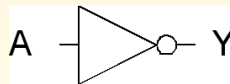


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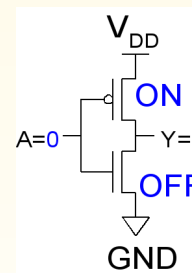
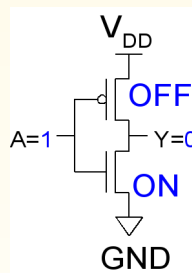
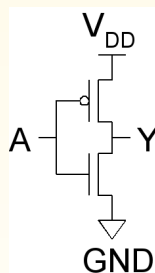
CMOS Inverter



A	Y
0	
1	

A	Y
0	
1	0

A	Y
0	1
1	0

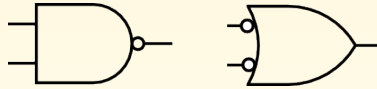


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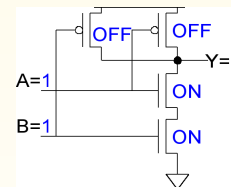
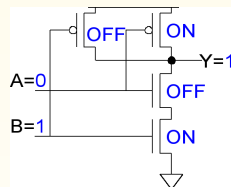
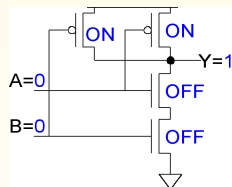
CMOS NAND Gate



A	B	Y
0	0	1
0	1	
1	0	
1	1	

A	B	Y
0	0	1
0	1	1
1	0	
1	1	

A	B	Y
0	0	1
0	1	1
1	0	1
1	1	0

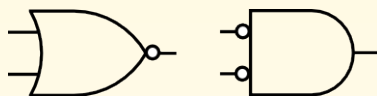


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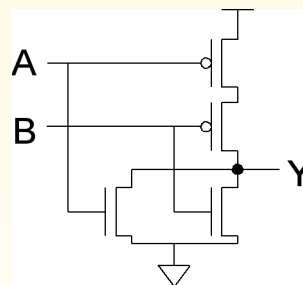
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CMOS NOR Gate



A	B	Y
0	0	1
0	1	0
1	0	0
1	1	0



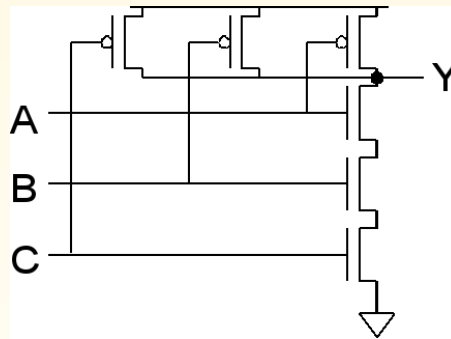
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3-Input NAND Gate

- Y pulls low if ALL inputs are 1
- Y pulls high if ANY input is 0



Characteristics of CMOS Gates

In general, when the circuit is stable

- There is a path from one supply (V_{DD} or V_{SS}) to the output (low static power dissipation)
- There is NEVER a path from one supply to another

When circuit is switching

- There is a momentary drain of current when a gate switches from one state to the other
- Dynamic power dissipation

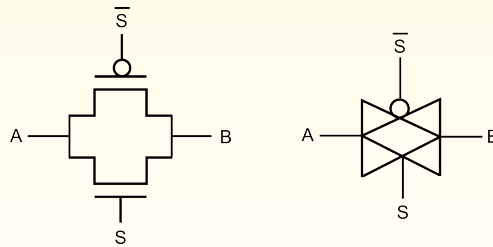
If a node has no path to power or ground, the previous value is retained due to the capacitance of the node

- Sometimes used as for dynamic storage

Complementary Switch (Transmission Gate)

Switch which does not degrade logic values

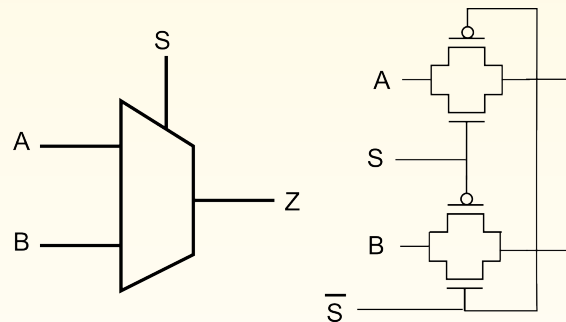
- Remember, the nMOS (pMOS) switch degrades a 1 (0)
- We'll analyze the electrical characteristics and see the reason for this next week
- Combine n- and p-channel switches in parallel to get a switch which passes both '1' and '0' well



Multiplexer

Two-input Multiplexer (MUX)
using only switches

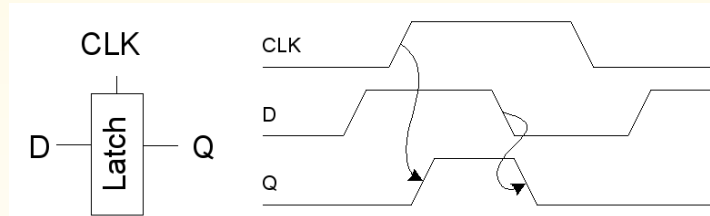
A	B	S	\bar{S}	Z	
X	0	0	1	0	B
X	1	0	1	1	
0	X	1	0	0	A
1	X	1	0	1	



D Latch

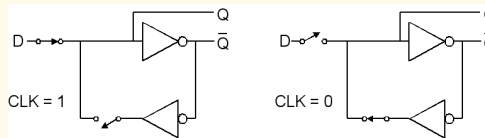
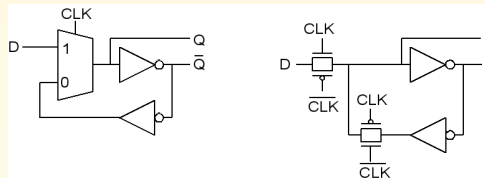
Basic Memory Element

- When $\text{CLK} = 1$, latch is transparent
 - D flows through to Q like a buffer
- When $\text{CLK} = 0$, the latch is opaque
 - Q holds its old value independent of D
- a.k.a., **transparent latch** or **level-sensitive latch**

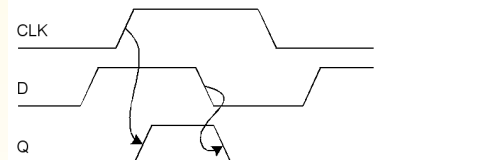


D Latch, Cont'd

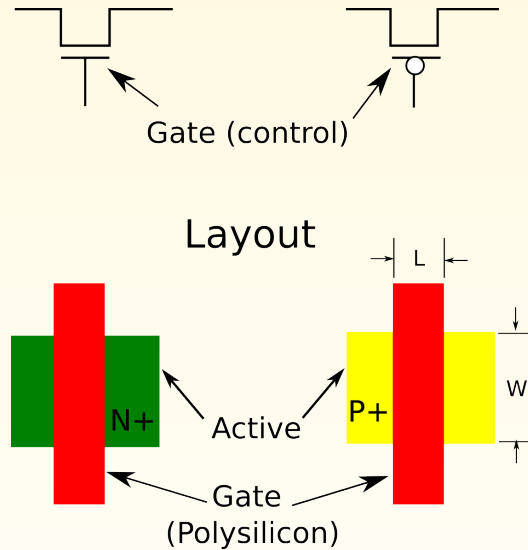
D Latch Design:
MUX chooses
between D and
old Q



D Latch
Operation



Layout – Implementing Transistors and Interconnect in Silicon



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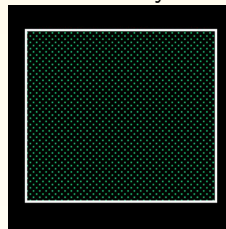
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Laying Out an nMOS Transistor in Cadence

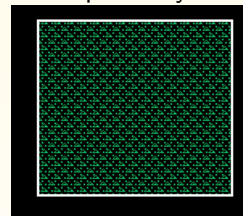
Transistors are implemented by layers

- pwell, active, nimplant, poly, metal1 and contact
 - Basic transistor (gate, source drain) implemented with active, nimplant and poly
 - pwell isolates transistors from other transistors – achieved with ties to appropriate potentials (power or ground)
 - contact connects nodes of the transistors to other nodes via metal

Active layer



Implant layer



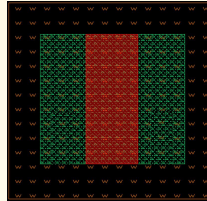
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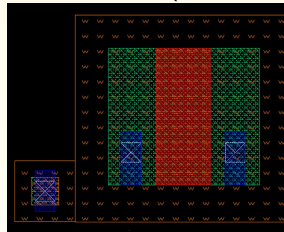
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Gate and Contacts

nMOS Transistor with p-Well



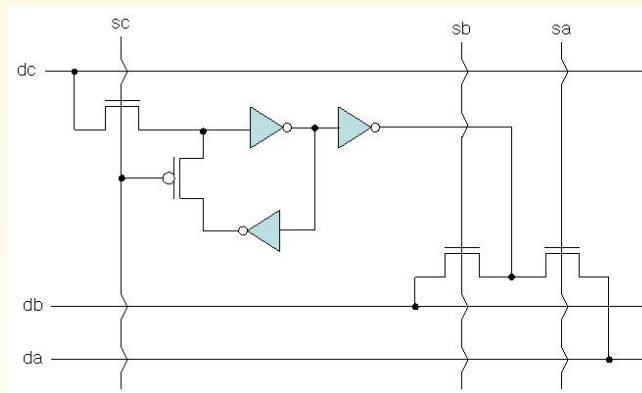
Transistor with Contacts (Source, Drain, Body)



Lab. 1 – 1-bit SRAM, 4×4 Array

Evaluation criteria: (a) Correct operation, (b) Area

1-bit memory cell



“Tile” this cell to make a 4×4 array

Evaluate performance of the array, with decoder